TSMP96000



Vishay Semiconductors

IR Sensor Module for Remote Control Systems



LINKS TO ADDITIONAL RESOURCES





DESCRIPTION

The TSMP96000 is a miniaturized sensor for receiving various kinds of modulated IR signals. A PIN diode and preamplifier are assembled on a lead frame, the epoxy package is designed as an IR filter. The modulated output signal, carrier out, can be used for code learning applications.

This component has not been gualified according to automotive specifications.

FEATURES

- · Photo detector and preamplifier in one package
- AC coupled response from 30 kHz to 60 kHz, all data formats
- Improved shielding against electrical field disturbance
- TTL and CMOS compatibility
- Output active low
- Supply voltage 2.0 V to 5.5 V
- · Carrier out signal for code learning functions
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

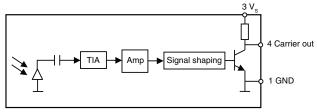
APPLICATIONS

Infrared receiver for code learning

DESIGN SUPPORT TOOLS

- 3D models
- Window size calculator

BLOCK DIAGRAM



19746-1



e3

RoHS COMPLIANT

HALOGEN

FREE **GREEN**

<u>(5-2008)</u>

TSMP96000

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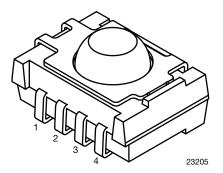
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MECHANICAL DATA

Pinning:

SHA

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$

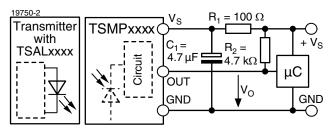


ORDERING CODE

Taping:

TSMP96000TT - top view taped, 1190 pcs/reel TSMP96000TR - side view taped, 1120 pcs/reel

APPLICATION CIRCUIT



 $\rm R_1$ + $\rm C_1$ recommended to suppress power supply disturbances. $\rm R_2$ recommended to get faster slopes and a correct high level of the output pulses.

PARTS TABLE				
Carrier frequency	30 kHz to 60 kHz	TSMP96000		
Package		Panhead		
Pinning		1 = GND, 2 = N.C., 3 = V _S , 4 = OUT		
Dimensions (mm)		7.5 W x 5.3 H x 4.0 D		
Mounting		SMD		
Application		Code learning		
Special options		 Narrow optical filter: <u>www.vishay.com/doc?81590</u> Wide optical filter: <u>www.vishay.com/doc?82726</u> 		

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Supply voltage (pin 3)		Vs	-0.3 to +6	V		
Output voltage (pin 4)		Vo	-0.3 to (V _S + 0.3)	V		
Output current (pin 4)		Ι _Ο	5	mA		
Junction temperature		Tj	100	°C		
Storage temperature range		T _{stg}	-25 to +85	°C		
Operating temperature range		T _{amb}	-25 to +85	°C		

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

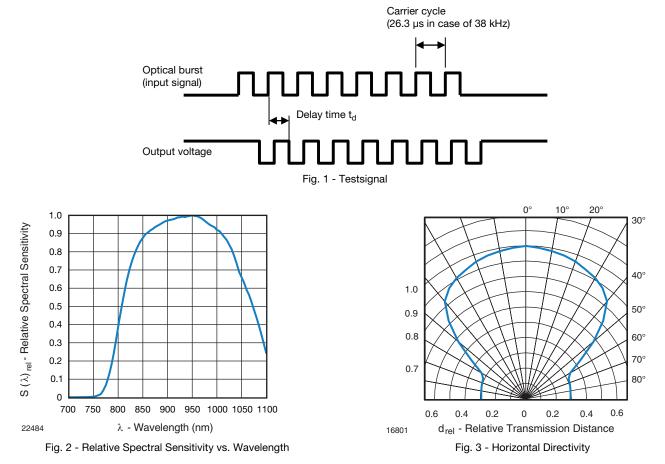


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ELECTRICAL AND OPTICAL CHARACTERISTICS CARRIER OUT $(T_{amb} = 25 \text{ °C}, \text{ unless otherwise specified}, V_S = 3 \text{ V})$						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	$V_{S} = 3.3 V, E_{v} = 0$	I _{SD}	0.25	0.35	0.45	mA
Supply voltage		Vs	2.0	-	5.5	V
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, I _F = 50 mA	d	-	1.8	-	m
Output voltage low (pin 4)	I _{OSL} = 0.5 mA, test signal see Fig. 1	V _{OSL}	-	-	250	mV
Minimum irradiance	V _S = 3 V, (30 kHz to 60 kHz)	E _{e min.}	-	12	25	mW/m ²
Maximum irradiance	Test signal see Fig. 1, (30 kHz to 60 kHz)	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Φ1/2	-	± 50	-	0
Output accuracy	f_C = 30 kHz to 60 kHz, E_e = 25 mW/m² to 30 W/m², test signal see Fig. 1, BER \leq 2%	N carrier pulses	Input burst length -1 cycle	Input burst length	Input burst length +1 cycle	counts

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



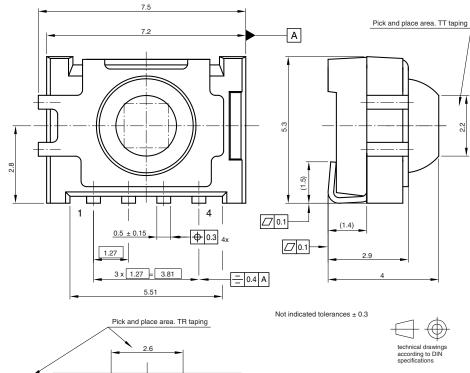




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PACKAGE DIMENSIONS in millimeters

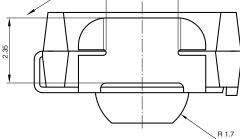


Footprint

1.27

3 x 1.27 = 3.81

0.9



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09

16776

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TSMP96000



• Use a soldering iron of 25 W or less. Adjust the

· Handle products only after the temperature has cooled off

temperature of the soldering iron below 300 °C



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

300 <u>max. 260</u> °C 255 °C 240 °C 250 245 °C 217 °C Temperature (°C) 200 max. 20 s 150 120 s max. 100 max 100 Max. ramp up 3 °C/s Max. ramp down 6 °C/s 50 Max. 2 cycles allowed 0 0 50 100 150 200 250 300 19800 Time (s)

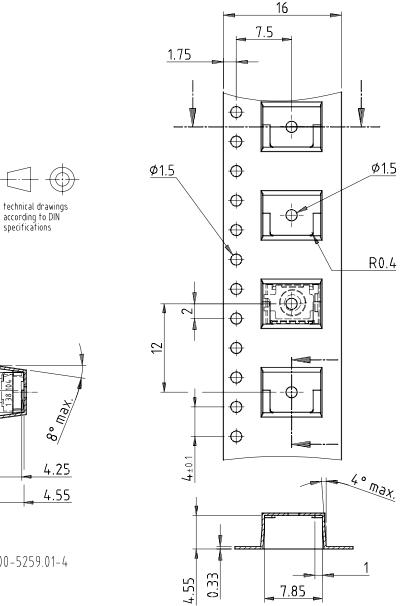
Manual Soldering

• Finish soldering within 3 s

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSMP..TT DIMENSIONS in millimeters



Drawing-No.: 9.700-5259.01-4 Issue: 1; 05.09.01 16584

2.45

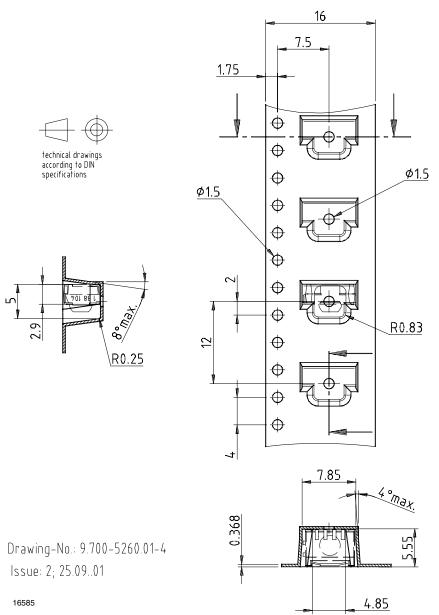
5.45

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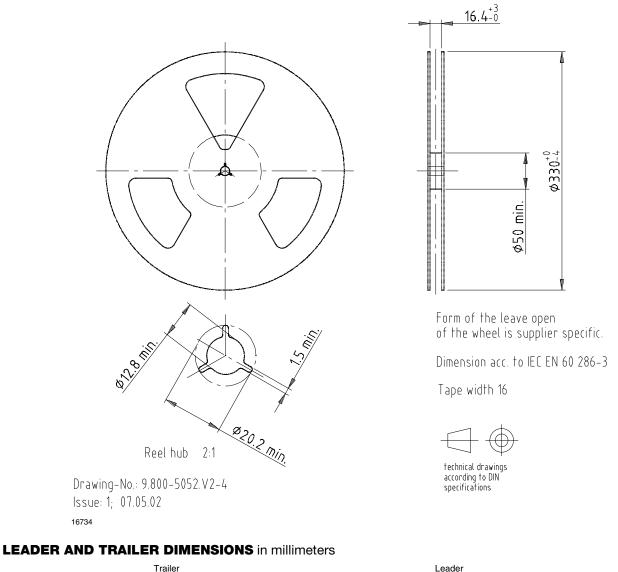
TAPING VERSION TSMP..TR DIMENSIONS in millimeters

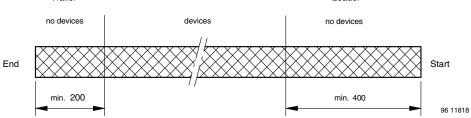






REEL DIMENSIONS in millimeters

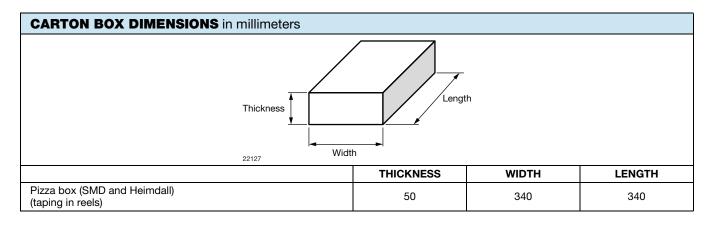






OUTER PACKAGING

The sealed reel is packed into a pizza box.



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

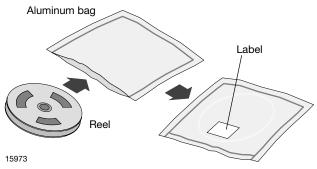
VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)				
PLAIN WRITTING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	XXXXXXX+	Company logo		
LONG BAR CODE TOP	ТҮРЕ	LENGTH		
Item-number	Ν	8		
Plant-code	Ν	2		
Sequence-number	Х	3		
Quantity	Ν	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH		
Selection-code	Х	3		
Data-code	Ν	3		
Batch-number	Х	10		
Filter	-	1		
Total length	-	17		

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DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

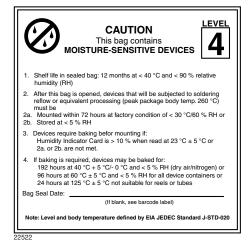
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ / - 0 $^{\circ}\text{C}$ and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

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ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





Vishay

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